FORM PTO-1449		U.S. Department of Commerce Patent and Trademark Office			Atty. Doo P29123	ket No.	Application No. 10/569,942				
INFORMATION DISCLOSURE STATEMENT BY APPLICANT						Applicant Akihiko ENDO et al.					
(Use several sheets if necessary)					Filing Da Septemb	te er 1, 2004	Group Unknown				
			U.S. PATENT	DOCUME	NTS						
EXAMINER INITIAL		DOCUMENT NUMBER	DATE		NAME	CLASS	SU	BCLASS	FILING DATE IF APPROPRIATE		
					· · · · · · · · · · · · · · · · · · ·						
							ļ				
							-				
							-				
							-				
							-				
							-				
							-				
							-				
			FOREIGN PATE	ENT DOCU	MENTS		-				
						I		T	TRANS	LATION	
		DOCUMENT NUMBER	DATE	COU	NTRY	CLASS	SUB	CLASS	YES NO		
		TP-MO-C-T									
					· · · · · · · · · · · · · · · · · · ·						
					v= ·		<u> </u>				
	Τ.,	OTHER DOCUMENT									
	1	U.S. Patent Application No. 11/851,065 (NISHIHATA et al.), which was filed on September 6, 2007 and entitled, "BONDED WAFER AND METHOD OF MANUFACTURING THE SAME."									
EXAMINER		,			TE CONS						
*EXAMINER	: Initial if	f citation considered, whether and not considered. Include	er or not citati	on is in c	onforman	ce with MPE	P 609); draw lir	ne throug	h citation	
	5a	ana not considered. Includ	ac copy of time	, IOITEL WI	THEY COL	umoalion	υαρ	piidani.			